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(54) **FIELD DEVICE AND METHOD FOR  
COMPACT ARRANGEMENT OF  
ELECTRONIC ASSEMBLIES OF AN  
ELECTRONIC CIRCUIT**

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(57) **ABSTRACT**

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A field device for process automation in industrial or private environments, comprising an electronic circuit for controlling the field device, wherein the electronic circuit includes a first, a second and a third circuit board. The first circuit board is connected to and attached to the second circuit board and/or to the third circuit board by way of an electrical connector, wherein the second circuit board is located above the third circuit board.

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